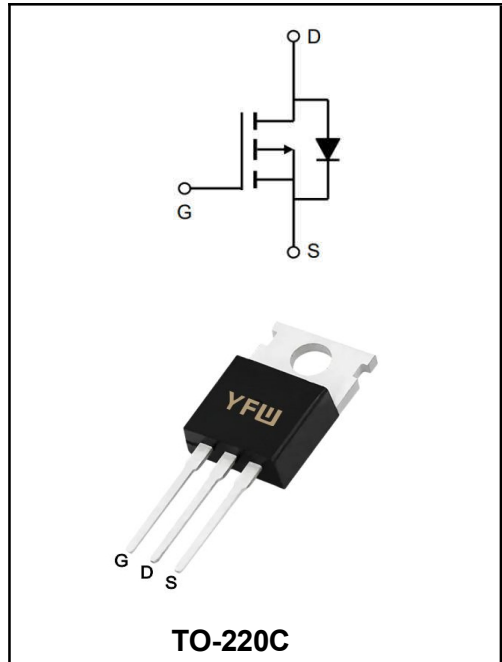


**-60V P-Channel Trench Power MOSFET**

**MAIN CHARACTERISTICS**

<b>I<sub>D</sub></b>	-80A
<b>V<sub>DS</sub></b>	-60V
<b>R<sub>DS(on)-typ(@V<sub>GS</sub>=-10V)</sub></b>	< 14mΩ (Typ: <b>9.8mΩ</b> )



**FEATURES**

- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge

**APPLICATIONS**

- Lithium battery protection
- Wireless impact
- Mobile phone fast charging

**MECHANICAL DATA**

- Case: TO-220C/AC
- Mounting Position: Any
- Molded Plastic: UL Flammability Classification Rating 94V-0
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Solder bath temperature 275°C maximum, 10s per JESD 22-B106

**Maximum Ratings at Tc=25°C unless otherwise specified**

Characteristics	Symbols	Value	Units
Drain-Source Voltage	<b>V<sub>DS</sub></b>	-60	<b>V</b>
Gate - Source Voltage	<b>V<sub>GSS</sub></b>	±20	<b>V</b>
Continuous Drain Current	<b>I<sub>D</sub></b>	-80	<b>A</b>
Pulsed Drain Current (note1)	<b>I<sub>DM</sub></b>	-320	<b>A</b>
Single Pulsed Avalanche Energy	<b>E<sub>AS</sub></b>	420	<b>mJ</b>
Power Dissipation	<b>P<sub>D</sub></b>	110	<b>W</b>
Operating Temperature Range	<b>T<sub>J</sub></b>	150	<b>°C</b>
Storage Temperature Range	<b>T<sub>STG</sub></b>	-55 to +150	<b>°C</b>
Thermal Resistance Junction to Case	<b>R<sub>θJC</sub></b>	0.7	<b>°C/W</b>
Thermal Resistance, Junction to Ambient	<b>R<sub>θJA</sub></b>	60	<b>°C/W</b>

**Note1: Pulse test: 300 μs pulse width, 2 % duty cycle**

**Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)**

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> = -250μA	<b>BV<sub>DSS</sub></b>	-60	-	-	<b>V</b>
Zero Gate Voltage Drain Current	V <sub>DS</sub> = -60V, V <sub>GS</sub> =0V,	<b>I<sub>DSS</sub></b>	-	-	-1	<b>μA</b>
Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> = ±20V	<b>I<sub>GSS</sub></b>	-	-	±100	<b>nA</b>
Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = -250μA	<b>V<sub>GS(th)</sub></b>	-1	-	-2	<b>V</b>
Static Drain-Source on-Resistance	V <sub>GS</sub> = -10V, I <sub>D</sub> = -10A	<b>R<sub>DS(on)</sub></b>	-	9.8	14	<b>mΩ</b>
	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -5A		-	11.5	16	<b>mΩ</b>
Input Capacitance	V <sub>DS</sub> =-15V V <sub>GS</sub> =0V f=1.0MHz	<b>C<sub>ISS</sub></b>	-	3350	-	<b>pF</b>
Output Capacitance		<b>C<sub>OSS</sub></b>	-	600	-	
Reverse Transfer Capacitance		<b>C<sub>RSS</sub></b>	-	23	-	
Turn-on Delay Time(Note2)	V <sub>DS</sub> = -30V I <sub>D</sub> = -30A V <sub>GS</sub> = -10V R <sub>G</sub> =3Ω	<b>t<sub>d(on)</sub></b>	-	4.1		<b>ns</b>
Turn-on Rise Time(Note2)		<b>T<sub>r</sub></b>	-	2.2		<b>ns</b>
Turn-off Delay Time(Note2)		<b>t<sub>d(OFF)</sub></b>	-	14.3		<b>ns</b>
Turn-off Fall Time(Note2)		<b>t<sub>f</sub></b>	-	3.5		<b>ns</b>
Total Gate Charge(Note2)		<b>Q<sub>g</sub></b>	-	53		<b>nC</b>
Gate to Source Charge(Note2)	V <sub>DS</sub> = -30V I <sub>D</sub> = -20A V <sub>GS</sub> = -10V	<b>Q<sub>gs</sub></b>	-	10		<b>nC</b>
Gate to Drain Charge(Note2)		<b>Q<sub>gd</sub></b>	-	9		<b>nC</b>
Maximun Body-Diode Continuous Current		<b>I<sub>S</sub></b>	-	-	-80	<b>A</b>
Maximun Body-Diode Pulsed Current(Note2)		<b>I<sub>SM</sub></b>	-	-	-320	<b>A</b>
Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> = -1A, T <sub>J</sub> =25°C	<b>V<sub>SD</sub></b>	-	-	-1.2	<b>V</b>

**Note2:Pulse test: 300 μs pulse width, 2 % duty cycle**

**RATINGS AND CHARACTERISTIC CURVES**

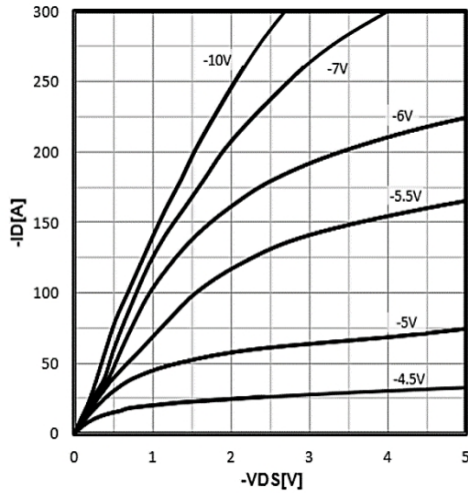


Figure 1. Type. Output Characteristics (Tj=25 °C)

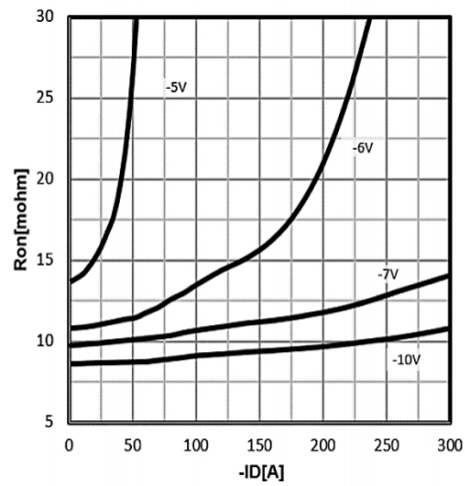


Figure 2. Type. drain-source on resistance

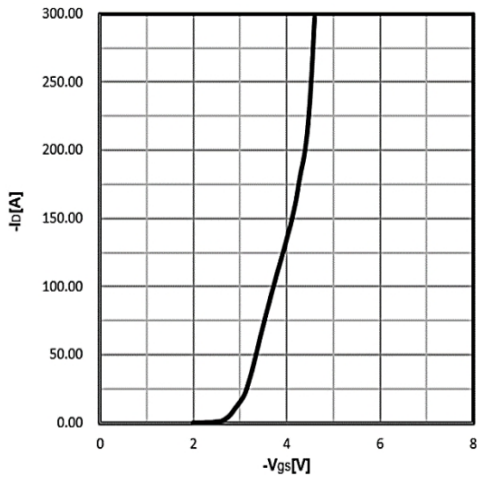


Figure 3. Type. transfer characteristics

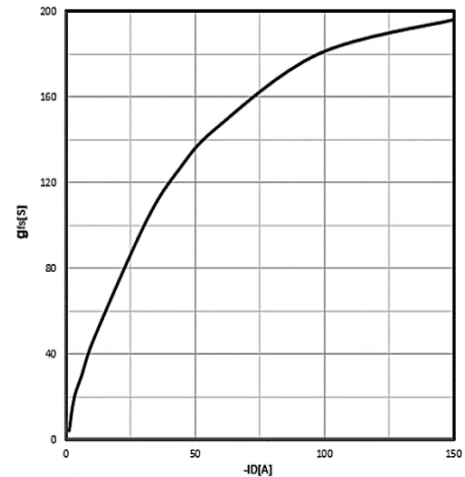


Figure 4. Type. forward transconductance

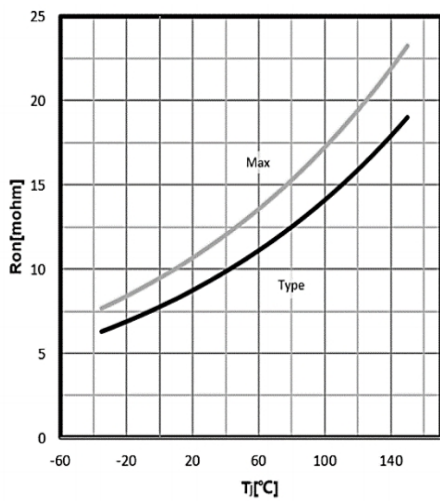


Figure 5. Drain-source on-state resistance  
RDS(on) = f(Tj); ID = 80A; VGS = 10V

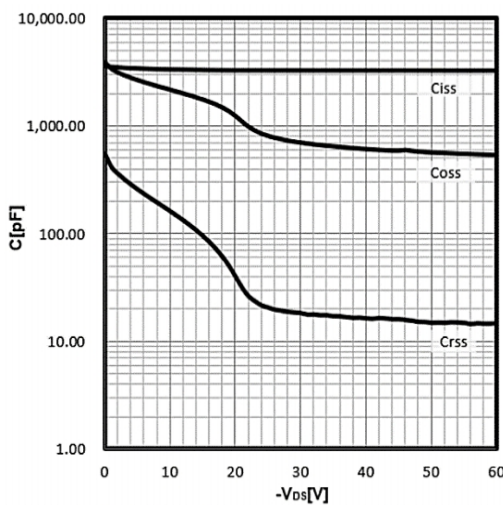


Figure 6 . Body-Diode Characteristics  
C=f(VDS); VGS = 0V; f=1MHz

RATINGS AND CHARACTERISTIC CURVES

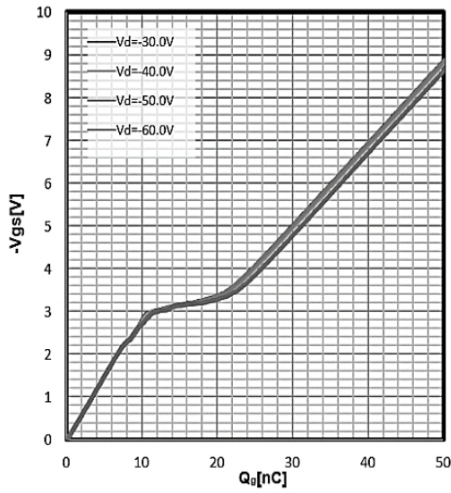


Figure 7. Typ. gate charge  
 $V_{GS} = f(Q_{gate})$ ;  $I_D = 20A$

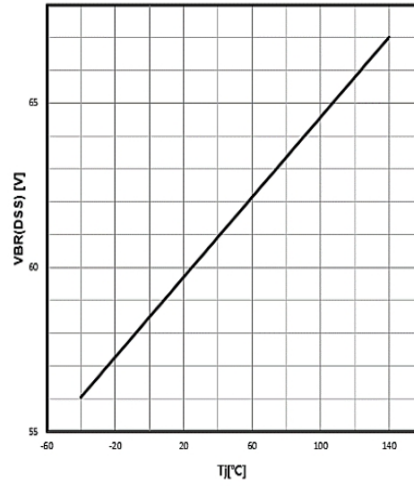


Figure 8. Drain Current Derating  
 $V_{BR}(DSS) = f(T_j)$ ;  $I_D = 250\mu A$

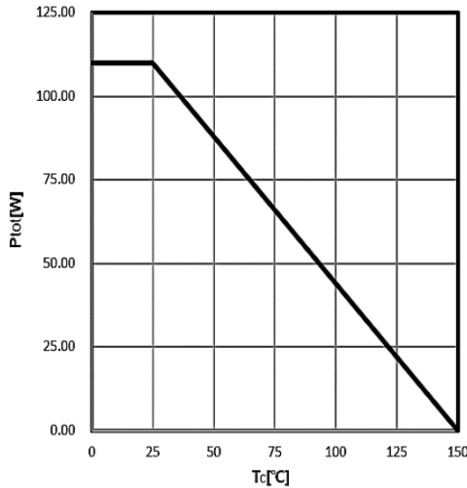


Figure 7. Power Dissipation

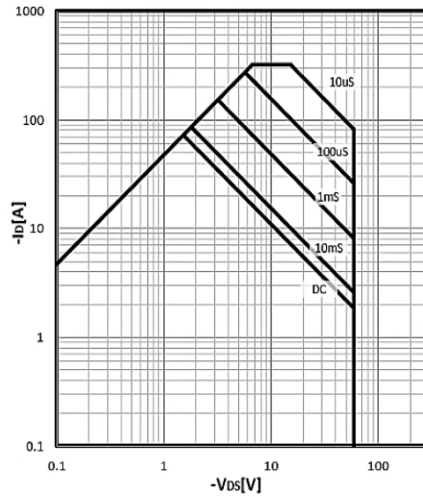


Figure 8. Safe operating area

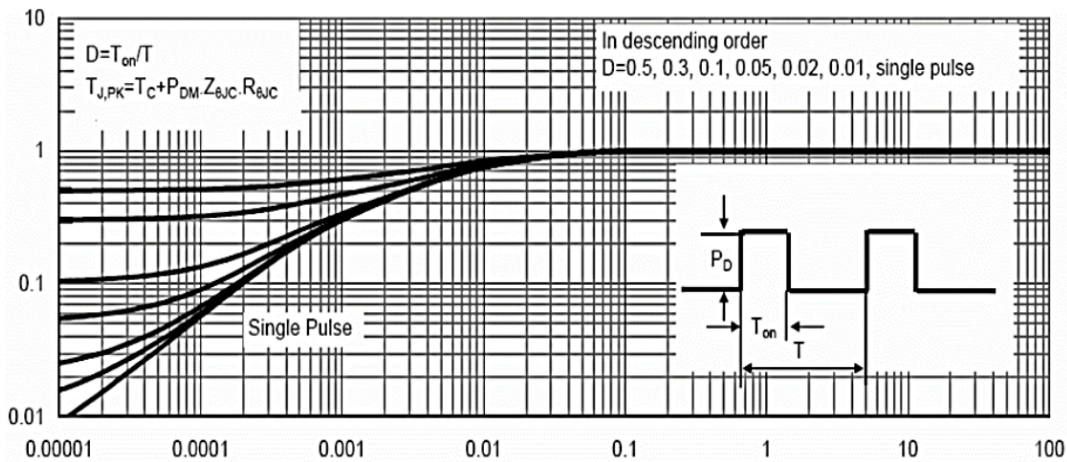
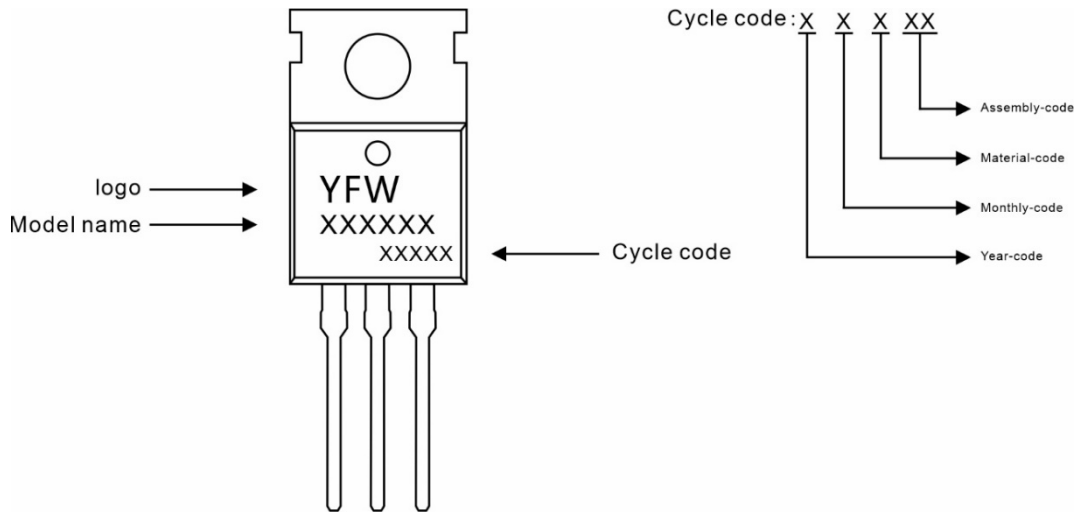


Figure 10. Max. transient thermal impedance

$Z_{thJC} = f(t_p)$

**Marking Diagram**



**Ordering information**

Model name	Package	Unit Weight	Base Quantity	Packing Quantity
YFW80P06AC	TO-220C	0.07oz(1.96g)	50pcs/tube	1000PCS/Box 5000PCS/Carton

**Package Dimensions**

**TO-220C**

Dim	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.34	4.67	0.171	0.184
A1	2.52	2.82	0.099	0.111
b	0.71	0.91	0.028	0.036
b1	1.17	1.37	0.046	0.054
c	0.30	0.50	0.012	0.020
c1	1.17	1.37	0.046	0.054
D	9.90	10.20	0.390	0.402
E	8.50	8.90	0.335	0.350
E1	12.00	12.50	0.472	0.492
e	2.44	2.64	0.096	0.104
e1	4.88	5.28	0.192	0.208
F	2.60	2.80	0.102	0.110
L	13.20	13.80	0.520	0.543
L1	3.80	4.20	0.150	0.165
Φ	3.60	3.96	0.142	0.156

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